

WHAT IS CLAIMED IS:

*suba1* 1. An exposure apparatus for printing, by exposure, a pattern of an original on a substrate, said apparatus comprising:

5 a housing tightly filled with a predetermined ambience and for accommodating therein at least a portion of an exposure light optical axis; and

a detection system having an optical system, wherein a portion of a light path of said detection  
10 system is disposed in a first space enclosed by said housing, and wherein at least another portion of said detection system including an electric element thereof is disposed in a second space outside said housing.

15 2. An apparatus according to Claim 1, wherein said housing is effective to tightly close one of (i) a space below a projection lens and accommodating the substrate therein and (ii) a space above the projection lens and accommodating the original  
20 therein.

*suba2* 3. An apparatus according to Claim 1, wherein said detection system is a detection system for executing focus adjustment of the substrate.

25 4. An apparatus according to Claim 3, wherein the electric element is one of a light source and a

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5. An apparatus according to Claim 1, wherein said detection system is a detection system for executing positional alignment between the original and the substrate.

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10. An apparatus according to Claim 1, further comprising a pressure reducing mechanism for applying

vacuum to said first space.

11. An apparatus according to Claim 10 comprising a window provided at an interface between said first and second spaces, for transmission of detection light of said detection system.

12. An apparatus according to Claim 10 wherein the oxygen concentration in said first space is maintained at not greater than 10 ppm.

13. An apparatus according to Claim 10 comprising a gas introducing mechanism for introducing an inactive gas into said first space.

14. An apparatus according to Claim 10 wherein a mixture of nitrogen and helium is introduced into said first space.

15. An apparatus according to Claim 10 wherein said second space is purged.

16. An apparatus according to Claim 10 wherein the light to be used for the exposure is laser light having a wavelength not greater than 248 nm.

17. An apparatus according to Claim 10 wherein the light to be used for the exposure is laser light having a wavelength not greater than 248 nm.

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light to be used for the exposure is fluorine excimer laser light.

18. A device manufacturing method, comprising the  
5 steps of:

placing a group of production machines for  
various processes, including an exposure apparatus for  
printing, by exposure, a pattern of an original on a  
substrate, in a semiconductor manufacturing factory,  
10 wherein the exposure apparatus includes (i) a housing  
tightly filled with a predetermined ambience and for  
accommodating therein at least a portion of an  
exposure light optical axis, and (ii) a detection  
system having an optical system, wherein a portion of  
15 the detection system is disposed in a first space  
enclosed by the housing, and wherein another portion  
of the detection system is disposed in a second space  
outside the housing; and

manufacturing a semiconductor device through  
20 plural processes using the production machine group.

19. A method according to Claim 18, further  
comprising (i) connecting the production machine group  
through a local area network, and (ii) executing data  
25 communication about information related to at least  
one production machine of the production machine group  
between the local area network and an external network

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outside the semiconductor manufacturing factory.

20. A method according to Claim 18, wherein a database provided by a production machine vendor or a user can be accessed through the external network so that information related to maintenance of the production machine can be obtained through data communication, and wherein production control can be made on the basis of data communication, through the external network, between the semiconductor manufacturing factory and a separate semiconductor manufacturing factory.

21. A semiconductor manufacturing factory, comprising:

a group of production machines for various processes, including an exposure apparatus for printing, by exposure, a pattern of an original on a substrate, wherein said exposure apparatus includes (i) a housing tightly filled with a predetermined ambience and for accommodating therein at least a portion of an exposure light optical axis, and (ii) a detection system having an optical system, wherein a portion of said detection system is disposed in a first space enclosed by the housing, and wherein another portion of said detection system is disposed in a second space outside the housing;

a local area network for connecting the  
production machine group; and

a gateway for enabling an access from the  
local area network to an external network outside the  
5 factory;

wherein information related to at least one  
production machine of the production machine group can  
be data communicated.

10 22. A method of executing maintenance for an  
exposure apparatus, provided in a semiconductor  
manufacturing factory and for printing, by exposure, a  
pattern of an original on a substrate, said method  
comprising the steps of:

15 preparing, by a vendor or a user of the  
exposure apparatus, a maintenance database connected  
to an external network outside the semiconductor  
manufacturing factory, wherein the exposure apparatus  
includes (i) a housing tightly filled with a  
20 predetermined ambience and for accommodating therein  
at least a portion of an exposure light optical axis,  
and (ii) a detection system having an optical system,  
wherein a portion of the detection system is disposed  
in a first space enclosed by the housing, and wherein  
25 another portion of said detection system is disposed  
in a second space outside the housing;

admitting an access from the semiconductor

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manufacturing factory to the maintenance database  
through the external network; and

transmitting maintenance information stored  
in the maintenance database to the semiconductor  
5 manufacturing factory through the external network.

23. An exposure apparatus for printing, by  
exposure, a pattern of an original on a substrate,  
said apparatus comprising:

10 a housing tightly filled with a predetermined  
ambience and for accommodating therein at least a  
portion of an exposure light optical axis;

a detection system having an optical system,  
wherein a portion of the detection system is disposed  
15 in a first space enclosed by the housing, and wherein  
another portion of the detection system is disposed in  
a second space outside the housing; and

a display;

a network interface; and

20 a computer for executing a network software;

wherein maintenance information related to  
said exposure apparatus can be data communicated from  
the network interface and through a network, by use of  
said display and said computer.

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24. An apparatus according to Claim 23, wherein  
the network software provides on the display a user

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and as

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